

ABSTRACT OF THE DISCLOSURE

The method for fabricating a ceramic substrate comprises the step of screen-printing a first dielectric material in a first region of a resin film 30 and screen-printing a second dielectric material of a dielectric constant different from that of the first dielectric material in a second region of the resin film 30 to form a layer including on the resin film 30 a high dielectric layer 20a of the first dielectric material and a base dielectric layer 24a of the second dielectric material, the step of releasing the layer from the resin film 30, and the step of sintering the layer released from the resin film 30.